DESCRIPTION

The SPN1306 is the N-Channel enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as notebook computer power management and other battery powered circuits where high-side switching, low in-line power loss, and resistance to transients are needed.

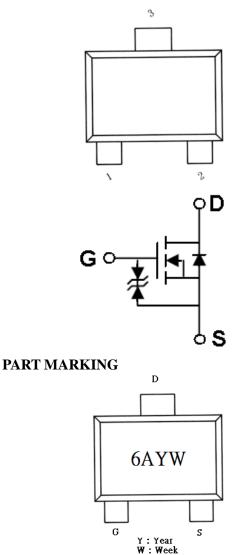
APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

FEATURES

- N-Channel 30V/0.95A,RDs(ON)=550mΩ@VGs=4.5V 30V/0.75A,RDs(ON)=650mΩ@VGs=2.5V 30V/0.65A,RDs(ON)=850mΩ@VGs=1.8V
- Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- ♦ ESD protected
- SOT-323 package design







PIN DESCRIPTION		
Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN1306S32RGB	SOT-323	6A

* SPN1306S32RGB : Tape Reel ; Pb – Free ; Halogen – Free ; 3K/Reel

ABSOULTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter		Symbol	Typical	Unit
Drain-Source Voltage		VDSS	30	V
Gate –Source Voltage		VGSS	±12	V
Continuous Drain Current(TJ=150°C)	Ta=25°C	Id	0.65	А
Pulsed Drain Current		Idm	2.8	Α
Continuous Source Current(Diode Conduction)		Is	0.3	Α
Power Dissipation	Ta=25°C	Pd	0.15	W
Operating Junction Temperature		TJ	-55/150	°C
Storage Temperature Range		TSTG	-55/150	°C

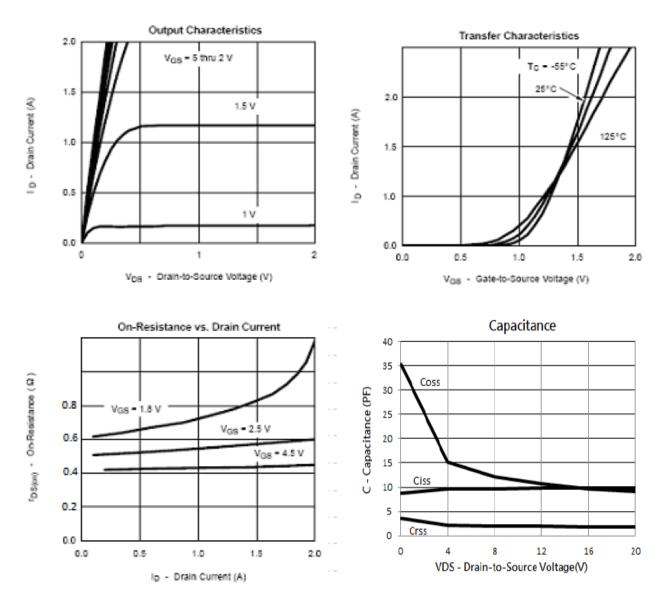


ELECTRICAL CHARACTERISTICS

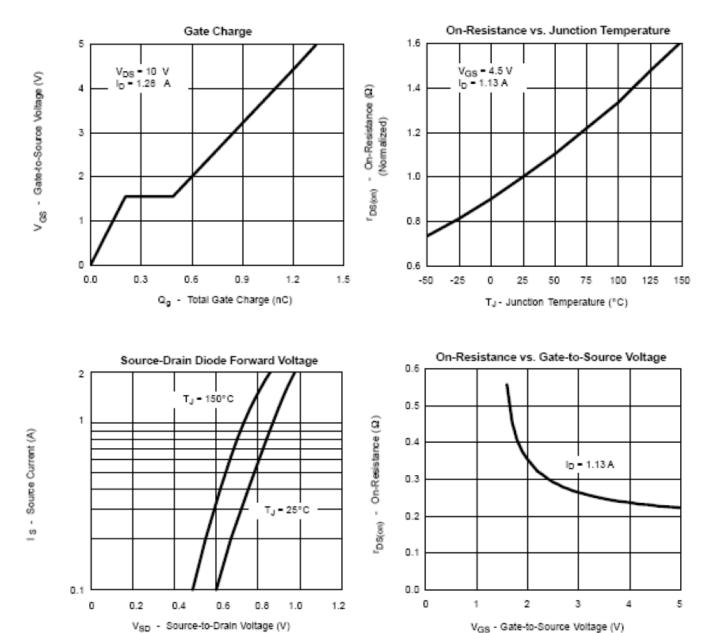
(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit	
Static		·					
Drain-Source Breakdown Voltage	V(BR)DSS	VGS=0V,ID= 250uA	30			v	
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=250uA	0.35		1.0		
Gate Leakage Current	Igss	VDS=0V,VGS=±12V			10	uA	
		VDS= 24V,VGS=0V	= 24V,VGS=0V		1		
Zero Gate Voltage Drain Current	Idss	Vds= 24V,Vgs=0V Tj=55°C			5	uA	
On-State Drain Current	ID(on)	$V_{DS} \ge 4.5V, V_{GS} = 5V$	0.7			A	
Drain-Source On-Resistance	RDS(on)	Vgs=4.5V,Id=0.95A		0.45	0.55	Ω	
		VGS=2.5V,ID=0.75A		0.50	0.65		
Forward Transconductance	ofo	VGS=1.8V,ID=0.65A VDS=10V,ID=0.4A		0.75	0.85	S	
	gfs	,			1.0		
Diode Forward Voltage	Vsd	Is=0.15A,Vgs=0V		0.8	1.2	V	
Dynamic							
Total Gate Charge	Qg	VDS=10V,VGS=4.5V,		1.2	1.5	nC	
Gate-Source Charge	Qgs	ID=0.6A		0.2			
Gate-Drain Charge	Qgd			0.3			
Input Capacitance	Ciss			7.2		pF	
Output Capacitance	Coss	VDS=10V, f=1MHz,		13.5			
Reverse Transfer Capacitance	Crss	VGS=0V		1.6			
Turn-On Time	td(on)	U 10UD 100		5	10	nS	
	tr	$VDD=10V,RL=10\Omega$, ID=0.5A		8	15		
Turn-Off Time	td(off)	VGEN=4.5V, RG=6 Ω		10	18		
	tf			1.2	2.8		

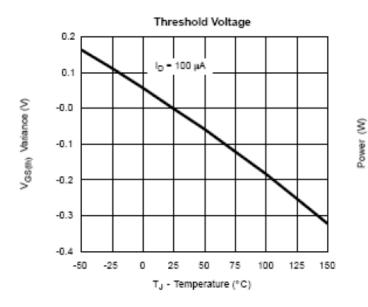
TYPICAL CHARACTERISTICS

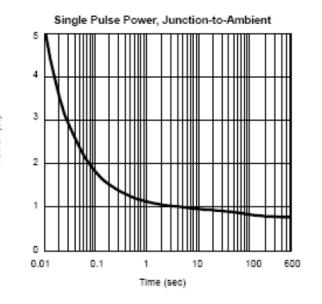


TYPICAL CHARACTERISTICS

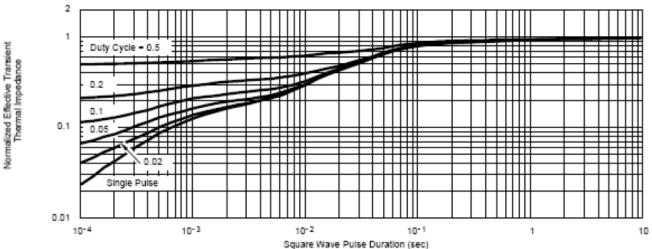


TYPICAL CHARACTERISTICS





Normalized Thermal Transient Impedance, Junction-to-Foot





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